

8. (Amended) An optoelectronic device as claimed in claim 1, wherein said substrate includes a multilayer printed circuit board for making electrical connections internally and/or externally of said housing.
9. (Amended) An optoelectronic device as claimed in claim 1, wherein said substrate includes a printed metallic layer to which the open end of the canister is bonded.
10. (Amended) An optoelectronic device as claimed in claim 1, wherein said substrate is a ceramic substrate.
11. (Amended) An optoelectronic device as claimed in Claim 1, wherein said substrate is a flex substrate.

REMARKS

The specification has been amended to include headings in accordance with US practice.

The Abstract of the Disclosure has been amended to eliminate reference numbers and to comply with MPEP 608.01(b).

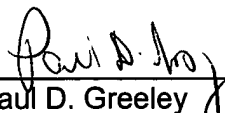
The claims have been amended to removed all multiply dependencies therefrom and to place them into proper U.S. format.

Consideration and allowance of application is respectfully requested.

Attached hereto is a marked up version of the changes made to the specification and claims by the current amendment. The attached page is captioned "Version With Markings to Show Changes Made."

Respectfully submitted,

2-17-03
Date



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